

Bluetooth® SDK 3.0.1.0 GA Gecko SDK Suite 3.0 September 9, 2020

Silicon Labs is a leading vendor in Bluetooth hardware and software technologies, used in products such as sports and fitness, consumer electronics, beacons, and smart home applications. The core SDK is an advanced Bluetooth 5-compliant stack that provides all of the core functionality along with multiple API to simplify development. The core functionality offers both standalone mode allowing a developer to create and run their application directly on the SoC, or in NCP mode allowing for the use of an external host MCU.

Extensions to the SDK include Bluetooth Mesh and Apple® HomeKit® for customers seeking the additional capabilities.

These release notes cover SDK version(s):

3.0.1.0 released on September 9, 2020 3.0.0.2 released on July 29, 2020



KEY FEATURES

- Integrated with Gecko Platform component-based architecture
- New Bluetooth stack API
- Support for 32 simultaneous connections
- Support for Randomized Advertising Channel Indexing
- Support for BGM220P and BGM220S modules added

Compatibility and Use Notices

If you are new to the Silicon Labs Bluetooth SDK, see Using This Release.

Compatible Compilers:

IAR Embedded Workbench for ARM (IAR-EWARM) version 8.30.1

- Using wine to build with the IarBuild.exe command line utility or IAR Embedded Workbench GUI on macOS or Linux could result in incorrect files being used due to collisions in wine's hashing algorithm for generating short file names.
- Customers on macOS or Linux are advised not to build with IAR outside of Simplicity Studio. Customers who do should carefully verify that the correct files are being used.

GCC (The GNU Compiler Collection) version 7.2.1, provided with Simplicity Studio.

Contents

1	New	Items	2		
•					
	1.1	New Features	2		
	1.2	New APIs	2		
2	Imp	ovements	3		
	2.1	Changed APIs	3		
3	Fixe	d Issues	4		
4	Kno	wn Issues in the Current Release	5		
5	Deprecated Items6				
6	Ren	noved Items	7		
7	Spe	cial Notices	8		
8	Usir	g This Release	9		
	8.1	Installation and Use	9		
	8.2	Support	9		
9	Leg	al	10		
	9.1	Disclaimer	10		
	9.2	Trademark Information	10		

1 New Items

1.1 New Features

Added in release 3.0.0.2

32 simultaneous connections

The stack supports up to 32 simultaneous connections on EFR32[B|M]G12 and EFR32[B|M]G21. On other parts, the actual maximum number of connections is restricted by available RAM space.

For the stack to successfully maintain more than 8 simultaneous connections and to maximize data throughput, allocate enough memory buffer in the Bluetooth > Feature > Bluetooth Core component, Buffer memory size for Bluetooth stack field. The configuration can also be directly changed in SL BT CONFIG BUFFER SIZE in sl bluetooth config.h.

The buffer memory is allocated in heap during Bluetooth stack initialization. Due to a limitation in IAR 8.30.1, which is unable to automatically expand the heap to the end of RAM space, the minimum heap size should be explicitly increased as well in the component Platform > Toolchain > Memory Configuration (install this component if it is not installed). This configuration can also be directly changed in SL_HEAP_SIZE in sl_memory_config.h.

Roughly, for each connection, a minimum of 100 bytes should be added to SL_BT_SL_BT_CONFIG_BUFFER_SIZE, and 600 bytes to SL_HEAP_SIZE.

Periodic Advertiser List Support

Applications can request to open multiple periodic advertiser synchronizations in parallel.

1.2 New APIs

For additional documentation and command descriptions please refer to the online API reference specific to the SDK version you are using. The most up-to-date version is at https://docs.silabs.com/bluetooth/latest/.

Added in release 3.0.0.2

sl_bt_cte_receiver_set_sync_cte_type

sl_bt_sync_set_parameters

2 Improvements

2.1 Changed APIs

Changed in release 3.0.0.2

The structure and overall interface of Bluetooth APIs are changed. For migrating from APIs on the v2.x SDK, refer to AN1255: Transitioning from the v2.x to the v3.x Bluetooth® SDK.

Additionally the Bluetooth SDK has a component Bluetooth > Bluetooth API migration helper that provides some helper messages for old APIs. When an application includes this component, compiling warnings or errors will be generated when old APIs from the v2.x SDK are used. For example:

3 Fixed Issues

Fixed in release 3.0.1.0

ID#	Description	
490308	In v3.0.0.2, DMP applications using the RAIL rail_lib_multiprotocol component don't have enough CSTACK and this may cause a Bluetooth connection to drop when sl_bt_sm_increase_security is called. This has been fixed by increasing the default CSTACK size in these applications.	
519382	The ncp_empty example now sends an sl_bt_evt_system_error_id event after receiving an incomplete API command from the NCP-host.	
520583	Added DTM test mode for NCP Empty example. It can be used for RF regulatory tests using BGTool.	

Fixed in release 3.0.0.0-Beta 2

ID#	Description	
455119	Remove compilation warnings from Bluetooth public API.	
460503	Now it is possible to set 0 MAX_CONNECTIONS and 0 MAX_ADVERTISERS in Bluetooth configuration.	
463724	Fix the Network Analyzer unable to decode a connection request packet when the connection is opened on LE Coded PHY.	
464918	Fix a performance issue that may cause advertising to fail if the application is compiled without optimization (-O0).	
470424	Improve connection scheduling to avoid connection starving during multiple simultaneous connections.	
481074	The ncp-empty application supports deep sleep now. To enable deep sleep, the wake lock component needs to be installed in ncp-empty.	
489021	If a scan report data longer than 238 bytes was received by the device while being low on available buffer memory, the scan report event could get corrupted. The application could receive a scan report event with invalid field values or missing payload data. This is fixed and now the application will receive valid scan report events.	
495892	Fix an issue causing the stack to hang when pairing with EFR Connect if a service in the local GATT database does not have a characteristic.	
496089	Fix an issue in the stack causing NVM3 operations to fail.	

4 Known Issues in the Current Release

Issues in bold were added since the previous release. If you have missed a release, recent release notes are available on https://www.si-labs.com/products/software.

ID#	Description	Workaround
337467	MGM12P has poor signal strength when doing OTA with Apploader.	None
361592	The sync_data event does not report TX power.	None
465088	BGTool works correctly on macOS Catalina, but may not launch successfully on older macOS versions.	None

5 Deprecated Items

None

6 Removed Items

Removed in release 3.0.0.2

Thunderboard Sense (SLTB001) and Thunderboard React (RD-0057-0201)

Support for Thunderboard Sense (SLTB001) and Thunderboard React (RD-0057-0201) is removed in this SDK release.

7 Special Notices

Silicon Labs Apple® HomeKit®

Silicon Labs implementation of Apple HomeKit is not currently available in GSDK 3. Silicon Labs is committed to providing an Apple HomeKit solution and is investigating ways to add support for it in a future release. Customers developing products targeting HomeKit applications may continue development using GSDK 2.7.x releases and upgrade to GSDK 3 when HomeKit is available.

8 Using This Release

This release contains the following

- Silicon Labs Bluetooth stack library
- · Bluetooth sample applications

For more information about the Bluetooth SDK see QSG169: Bluetooth® SDK v3.x Quick Start Guide. If you are new to Bluetooth see UG103.14: Bluetooth LE Fundamentals.

8.1 Installation and Use

A registered account at Silicon Labs is required in order to download the Silicon Labs Bluetooth SDK. You can register at https://siliconlabs.force.com/apex/SL CommunitiesSelfReg?form=short.

Stack installation instruction are covered in the Simplicity Studio 5 online User's Guide.

Use the Bluetooth SDK v3.x with the Silicon Labs Simplicity Studio 5 development platform. Simplicity Studio ensures that most software and tool compatibilities are managed correctly. Install software and board firmware updates promptly when you are notified. Only use Simplicity Studio 4 with Bluetooth SDK v2.13.x and lower.

Documentation specific to the SDK version is installed with the SDK. Additional information can often be found in the knowledge base articles (KBAs). API references and other information about this and earlier releases is available on https://docs.silabs.com/.

8.2 Support

Development Kit customers are eligible for training and technical support. Use the Silicon Labs Bluetooth LE web page to obtain information about all Silicon Labs Bluetooth products and services, and to sign up for product support.

You can contact Silicon Laboratories support at http://www.silabs.com/support.

9 Legal

9.1 Disclaimer

Silicon Labs intends to provide customers with the latest, accurate, and in-depth documentation of all peripherals and modules available for system and software implementers using or intending to use the Silicon Labs products. Characterization data, available modules and peripherals, memory sizes and memory addresses refer to each specific device, and "Typical" parameters provided can and do vary in different applications.

Application examples described herein are for illustrative purposes only.

Silicon Labs reserves the right to make changes without further notice and limitation to product information, specifications, and descriptions herein, and does not give warranties as to the accuracy or completeness of the included information. Silicon Labs shall have no liability for the consequences of use of the information supplied herein. This document does not imply or express copyright licenses granted hereunder to design or fabricate any integrated circuits. The products are not designed or authorized to be used within any Life Support System. A "Life Support System" is any product or system intended to support or sustain life and/or health, which, if it fails, can be reasonably expected to result in significant personal injury or death. Silicon Labs products are not designed or authorized for military applications. Silicon Labs products shall under no circumstances be used in weapons of mass destruction including (but not limited to) nuclear, biological or chemical weapons, or missiles capable of delivering such weapons.

9.2 Trademark Information

Silicon Laboratories Inc.®, Silicon Laboratories®, Silicon Labs®, SiLabs® and the Silicon Labs logo®, Bluegiga®, Bluegiga Logo®, Clockbuilder®, CMEMS®, DSPLL®, EFM®, EFM32®, EFR, Ember®, Energy Micro, Energy Micro logo and combinations thereof, "the world's most energy friendly microcontrollers", Ember®, EZLink®, EZRadio®, EZRadioPRO®, Gecko®, ISOmodem®, Micrium, Precision32®, ProSLIC®, Simplicity Studio®, SiPHY®, Telegesis, the Telegesis Logo®, USBXpress®, Zentri, Z-Wave and others are trademarks or registered trademarks of Silicon Labs.

ARM, CORTEX, Cortex-M0+, Cortex-M3, Cortex-M4, TrustZone, Keil and Thumb are trademarks or registered trademarks of ARM Holdings.

Zigbee® and the Zigbee logo® are registered trademarks of the Zigbee Alliance.

Bluetooth® and the Bluetooth logo® are registered trademarks of Bluetooth SIG Inc.

Apple and HomeKit are registered trademarks of Apple Inc.

All other products or brand names mentioned herein are trademarks of their respective holders.